

60V Nch+Nch Power MOSFET

V_{DSS}	60V
R _{DS(on)} (Max.)	90mΩ
I _D	±3.0A
P_D	1.5W

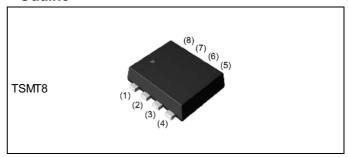
Features

- 1) Low on resistance
- 2) Small Surface Mount Package (TSMT8)
- 3) Pb-free plating; RoHS compliant
- 4) Halogen Free

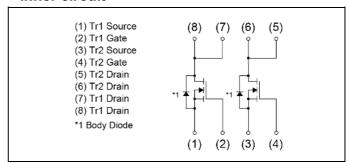
Application

Switching

Outline



•Inner circuit



Packaging specifications

	Packing	Embossed Tape
	Reel size (mm)	180
Туре	Tape width (mm)	8
	Quantity (pcs)	3000
	Taping code	TCR
	Marking	KC5

● **Absolute maximum ratings** (T_a = 25°C ,unless otherwise specified) < Tr1 and Tr2>

Parameter	Symbol	Value	Unit
Drain - Source voltage	V _{DSS}	60	V
Continuous drain current	I _D	±3.0	Α
Pulsed drain current	I _{DP} *1	±12	Α
Gate - Source voltage	V _{GSS}	±20	V
Avalanche current, single pulse	I _{AS} *2	3.0	Α
Avalanche energy, single pulse	E _{AS} *2	0.7	mJ
Douger discipation (total)	P _D *3	1.5	W
Power dissipation (total)	P _D *4	1.1] VV
Junction temperature	T _j	150	°C
Operating junction and storage temperature range	T _{stg}	-55 to +150	°C

Thermal resistance

Doromotor	Cymhol	Values			l leit
Parameter	Symbol	Min.	Тур.	Max.	Unit
Thermal registence, junction, ambient (total)	R _{thJA} *3	-	-	83.3	°C/W
Thermal resistance, junction - ambient (total)	R _{thJA} *4	-	-	113	

● Electrical characteristics (T_a = 25°C) < Tr1 and Tr2>

D .		0 177	Values			I India	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Drain - Source breakdown voltage	V _{(BR)DSS}	$V_{GS} = 0V$, $I_D = 1mA$	60	-	-	V	
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_{j}}$	I _D = 1mA referenced to 25°C	-	38.9	-	mV/°C	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 60V, V _{GS} = 0V		-	1	μA	
Gate - Source leakage current	I _{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$		-	±100	nA	
Gate threshold voltage	V _{GS(th)}	$V_{GS(th)}$ $V_{DS} = V_{GS}$, $I_D = 1mA$		-	2.5	V	
Gate threshold voltage temperature coefficient $ \frac{\Delta V_{\text{GS(th)}}}{\Delta T_{j}} I_{D} = 1 \text{mA} $ referenced to 25°C		-	-4.7	-	mV/°C		
Static drain - source	D *5	V _{GS} = 10V, I _D = 3.0A	-	70	90	0	
on - state resistance	R _{DS(on)} *5	V _{GS} = 4.5V, I _D = 3.0A	-	100	140	mΩ	
Gate resistance	R_G	-	-	2.7	-	Ω	
Forward Transfer Admittance	$ Y_{fs} ^{*5}$ $V_{DS} = 5.0V, I_D = 3.0A$		1.3	-	-	S	

^{*1} Pw ≤ 10µs, Duty cycle ≤ 1%

^{*2} L \simeq 0.1mH, V_{DD} = 30V, R_G = 25 Ω , Starting T_j = 25 $^{\circ}$ C Fig.3-1,3-2

^{*3} Mounted on a ceramic board (30×30×0.8mm)

^{*4} Mounted on a FR4 (25×25×0.8mm)

^{*5} Pulsed

● Electrical characteristics (T_a = 25°C) < Tr1 and Tr2>

Daramatar	Cymahal	Conditions	Values			Unit	
Parameter	Symbol Conditions -		Min.	Тур.	Max.	Uill	
Input capacitance	C _{iss}	V _{GS} = 0V	-	135	-		
Output capacitance	C _{oss}	V _{DS} = 30V	-	38	-	pF	
Reverse transfer capacitance	C _{rss}	C_{rss} $f = 1MHz$		6	-		
Turn - on delay time	t _{d(on)} *5	V _{DD} ≈ 30V,V _{GS} = 10V	-	5.3	-		
Rise time	t _r *5	I _D = 1.5A	-	4.8	-		
Turn - off delay time	t _{d(off)} *5	$R_L = 20\Omega$	-	13.0	-	ns	
Fall time	t _f *5	$R_G = 10\Omega$	-	3.1	-		

● Gate charge characteristics (T_a = 25°C) < Tr1 and Tr2>

Darameter	Cumbal	Canditions		Values			1 1:4
Parameter	Symbol Conditions -		Min.	Тур.	Max.	Unit	
Total mate above	O *5	Q_g^{*5} $V_{DD} \simeq 30V$	V _{GS} = 10V	-	3.1	-	
Total gate charge	Q_g			-	1.7	-	0
Gate - Source charge	Q _{gs} *5		V _{GS} = 4.5V	-	0.9	-	nC
Gate - Drain charge	Q _{gd} *5			-	0.3	-	

● Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

<Tr1 and Tr2>

Parameter	Symbol	Conditions	Values			Unit	
raianetei	Symbol	Conditions	Min.	Тур.	Max.	Offic	
Continuous forward current	I _S	T _a = 25°C	-	-	1.25	^	
Pulse forward current	I _{SP} *1	1 _a – 25 C	ı	ı	12	A	
Forward voltage	V _{SD} *5	V _{GS} = 0V, I _S = 1.25A	-	-	1.2	٧	
Reverse recovery time	t _{rr} *5	I _S = 3.0A, V _{GS} = 0V	-	23	-	ns	
Reverse recovery charge	Q _{rr} *5	di/dt = 100A/μs	-	20	-	nC	

Fig.1 Power Dissipation Derating Curve

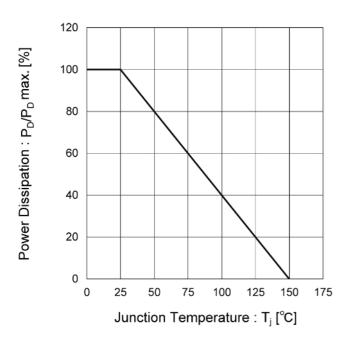
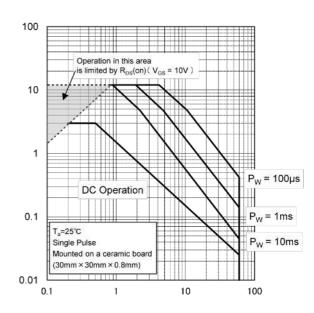


Fig.2 Maximum Safe Operating Area



Drain Current : I_D [A]

Drain - Source Voltage : V_{DS} [V]

Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

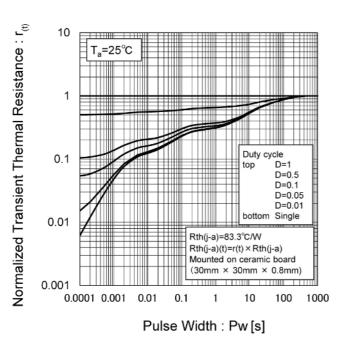
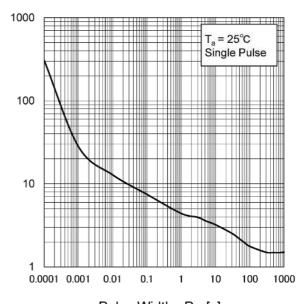


Fig.4 Single Pulse Maximum Power Dissipation



Peak Transient Power: P(W)

Fig.5 Typical Output Characteristics(I)

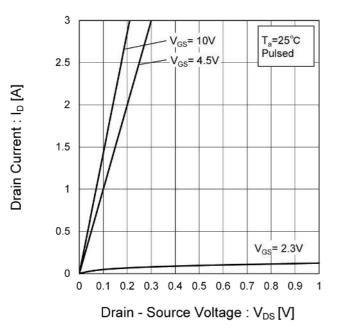


Fig.6 Typical Output Characteristics(II)

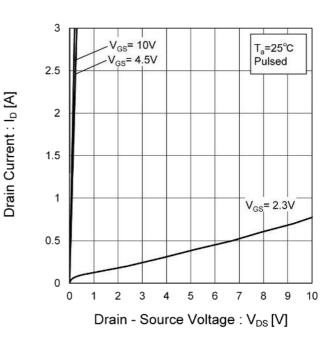


Fig.7 Breakdown Voltage vs.
Junction Temperature

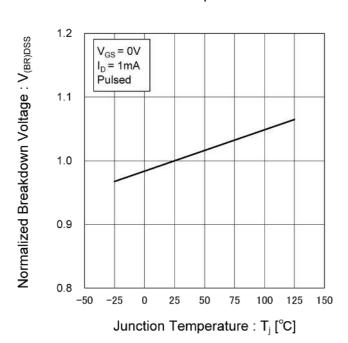


Fig.8 Typical Transfer Characteristics

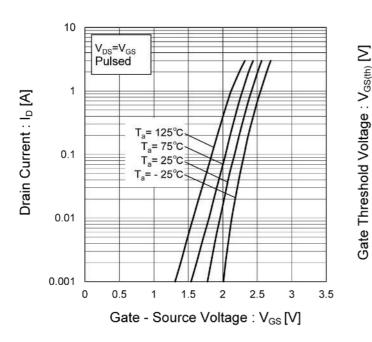


Fig.9 Gate Threshold Voltage vs.
Junction Temperature

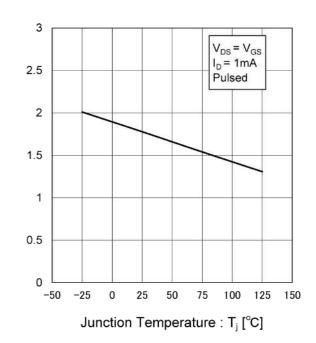


Fig.10 Forward Transfer Admittance vs.
Drain Current

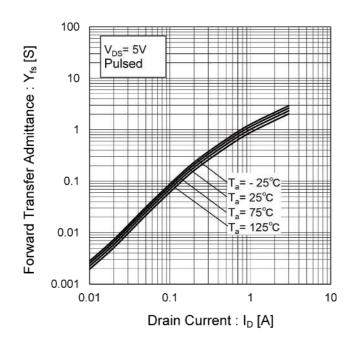


Fig.11 Drain Current Derating Curve

120 100 **Drain Current Dissipation** 80 : I_D/I_Dmax. [%] 60 40 20 0 -25 25 50 75 100 125 150 Junction Temperature : T_j [°C]

Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage

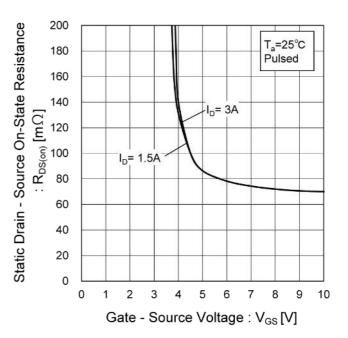


Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature

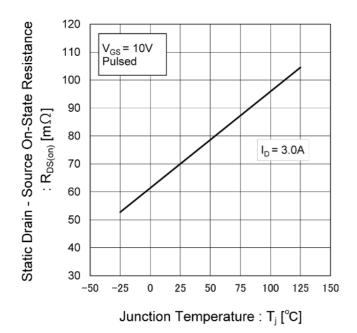


Fig.14 Static Drain - Source On - State Resistance vs. Drain Current (I)

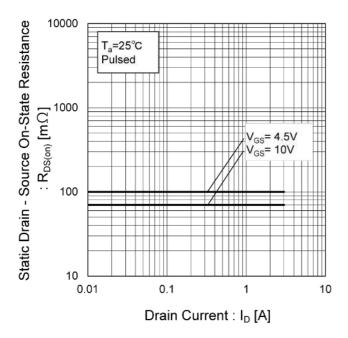


Fig.15 Static Drain - Source On - State Resistance vs. Drain Current (II)

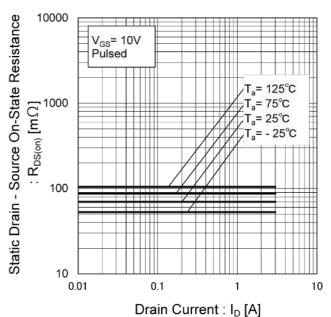


Fig.16 Static Drain - Source On - State Resistance vs. Drain Current (III)

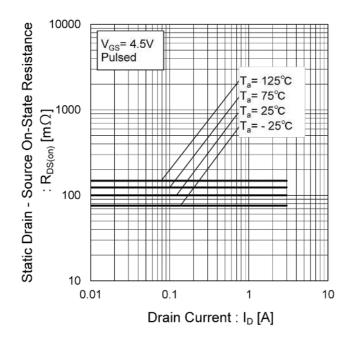


Fig.17 Typical Capacitances vs.

Drain - Source Voltage

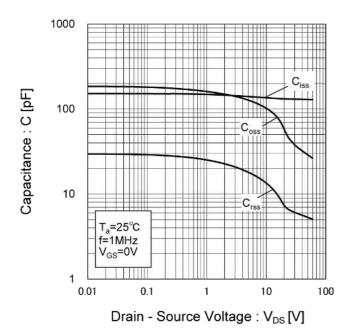


Fig.18 Switching Characteristics

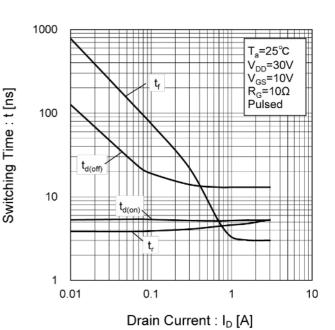


Fig.19 Typical Gate Charge

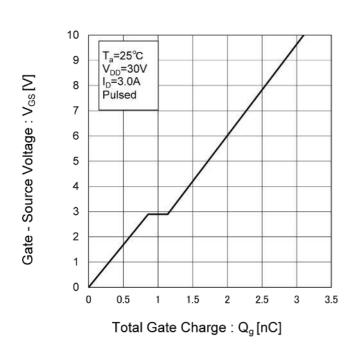
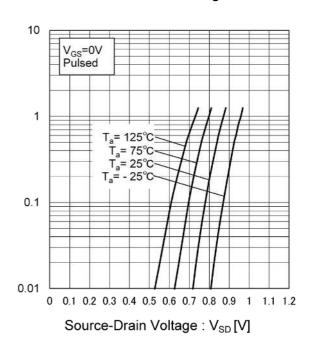


Fig.20 Source Current vs.

Source Drain Voltage



Source Current : Is [A]

• Measurement circuits < It is the same for the Tr1 and Tr2>

Fig.1-1 Switching Time Measurement Circuit

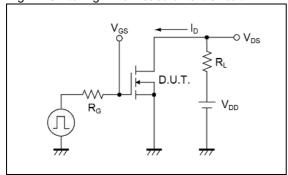


Fig.2-1 Gate Charge Measurement Circuit

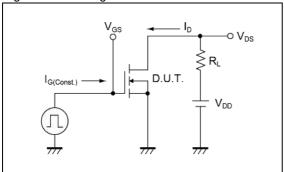


Fig.3-1 Avalanche Measurement Circuit

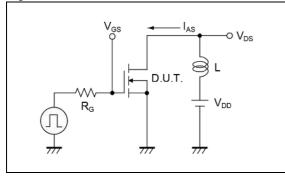


Fig.1-2 Switching Waveforms

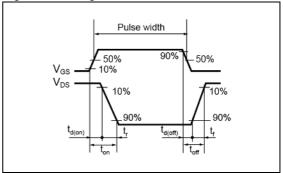


Fig.2-2 Gate Charge Waveform

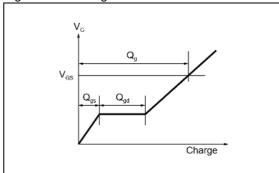
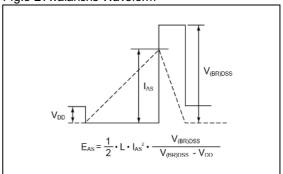


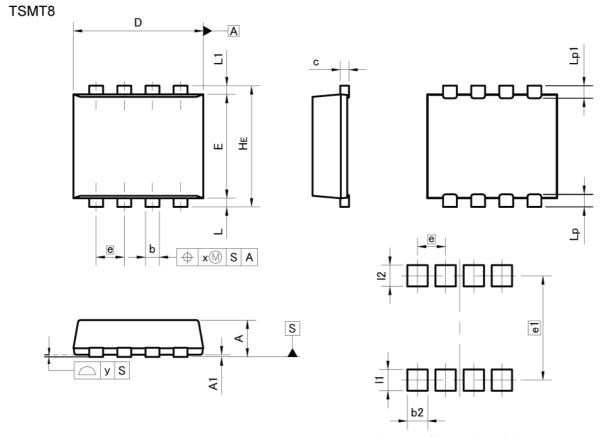
Fig.3-2 Avalanche Waveform



Notice

This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.

Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM [MIN	MAX	MIN	MAX
Α	0.75	0.85	0.030	0.033
A1	0.00	0.05	0.000	0.002
b	0.27	0.37	0.011	0.015
С	0.12	0.22	0.005	0.009
D	2.90	3.10	0.114	0.122
E	2.30	2.50	0.091	0.098
е	0.	65	0.0	26
HE	2.70	2.90	0.106	0.114
L	0.10	0.30	0.004	0.012
L1	0.10	0.30	0.004	0.012
Lp	0.19	0.39	0.007	0.015
Lp1	0.19	0.39	0.007	0.015
х	825	0.10		0.004
у	85	0.10	-	0.004

DIM	MILIM	MILIMETERS		HES
DIM	MIN	MAX	MIN	MAX
b2	100	0.47		0.019
e1	2.41		0.0	095
11	33 00	0.49		0.019
12	-	0.49	3 3	0.019

Dimension in mm/inches



Notice

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(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASSⅢ	CL ACCTI	CLASS II b	СГУССШ
CLASSIV	CLASSII	CLASSⅢ	CLASSⅢ

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
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 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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